



BSI Standards Publication

Electronic components — Long-term storage of electronic semiconductor devices

Part 3: Data

National foreword

This British Standard is the UK implementation of EN IEC 62435-3:2020. It is identical to IEC 62435-3:2020.

The UK participation in its preparation was entrusted to Technical Committee EPL/47, Semiconductors.

A list of organizations represented on this committee can be obtained on request to its secretary.

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(IEC 62435-3:2020)

Elektronische Bauteile - Langzeitlagerung elektronischer
Halbleiterbauelemente - Teil 3: Daten
(IEC 62435-3:2020)

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European Committee for Electrotechnical Standardization
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European foreword

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IEC 60068-2-17:1994	NOTE	Harmonized as EN 60068-2-17:1994 (not modified)
IEC 60068-2-20:2008	NOTE	Harmonized as EN 60068-2-20:2008 (not modified)
IEC 60749-20-1	NOTE	Harmonized as EN 60749-20-1
IEC 60749-21	NOTE	Harmonized as EN 60749-21
IEC 61340-5-1	NOTE	Harmonized as EN 61340-5-1
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IEC 62435-2	NOTE	Harmonized as EN 62435-2
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INTERNATIONAL ELECTROTECHNICAL COMMISSION

**ELECTRONIC COMPONENTS – LONG-TERM STORAGE
OF ELECTRONIC SEMICONDUCTOR DEVICES –****Part 3: Data****FOREWORD**

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47/2608/FDIS	47/2615/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.